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Class	Subclass
ISSUE CLASSIFICATION	

U.S. UTILITY Patent Application

PATENT DATE

REV.
PTO-1305

DOE

NASA
US COMM-DC

APPLICATION NO.
09/731726

CONT/PRIOR	
F	

CLASS
257

SUBCLASS
11

ART UNID
2811

EXAMINER

CANTS Kozo Shimizu
Masayuki Ochiai
Yasuo Yamagishi

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Solder alloy, a circuit substrate, a semiconductor device and a method of manufacturing the same

PTO-2040
12/89

ISSUING CLASSIFICATION

ORIGINAL				CROSS REFERENCE(S)								
CLASS		SUBCLASS		CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)							
INTERNATIONAL CLASSIFICATION												

☐ Continued on Issue Slip inside File Jacket

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input checked="" type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	_____ (Assistant Examiner) (Date)			NOTICE OF ALLOWANCE MAILED	
	_____ (Primary Examiner) (Date)			ISSUE FEE	
				Amount Due	Date Paid
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____ _____					
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) (Date)			ISSUE BATCH NUMBER	

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